Thermoelectric Module



Scope

This specification is applied to multicomp thermoelectric modules Revision of these specifications is carried out after consent

Specifications

Para	Remarks		
Internal resistance	2.26 Ω	Note-1	
I max.	3.2	Note-2	
V max.	8.8	Note-3	
-	Th = 25°C	-	-
Q max.	16.5 W	-	Note-4
ΔT max.	72°C	-	Note-5
Solder melting point	138	Note-6	
Maximum compress	1 M	Note-7	

Note-1: Measured by AC 4 - terminal method at 25°C

Note-2 : Maximum current at ΔT max. Note-3: Maximum voltage at ΔT max.

Note-4: Maximum cooling capacity at I max. V max. and $\Delta T = 0$ °C

Note-5: Maximum temperature difference at I max. V max. and Q = 0 W

(Maximum parameters are measured in a vacuum 1.3 P) Note-6: The solder melting point of thermoelectric module

Note-7: Recommended maximum compression (not destruction limit)

Recommendations

Maximum temperature for short time: 110°C Operation temperature up to 90°C for long lifetime

Good reliability in ON-OFF mode

Recommended operation current not higher than 0.7 of I max.

Specification Table Thot = $27^{\circ}C$

I max. (A)	U max. (V)	Qc max. W	dT max. °C	Α	В	Н	Part Number
3.2	8.8	17	74	20	20	3.8	MCPE-071-10-15

Dimensions: Millimetres

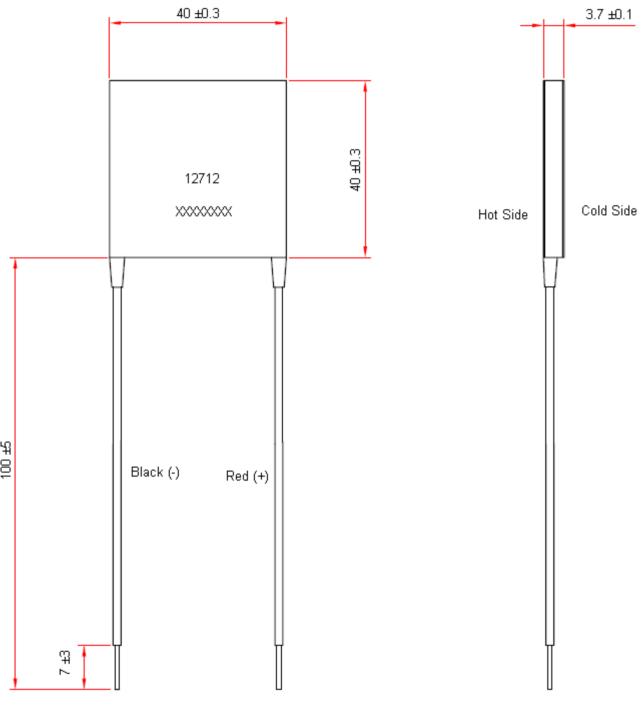




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Outline Drawing



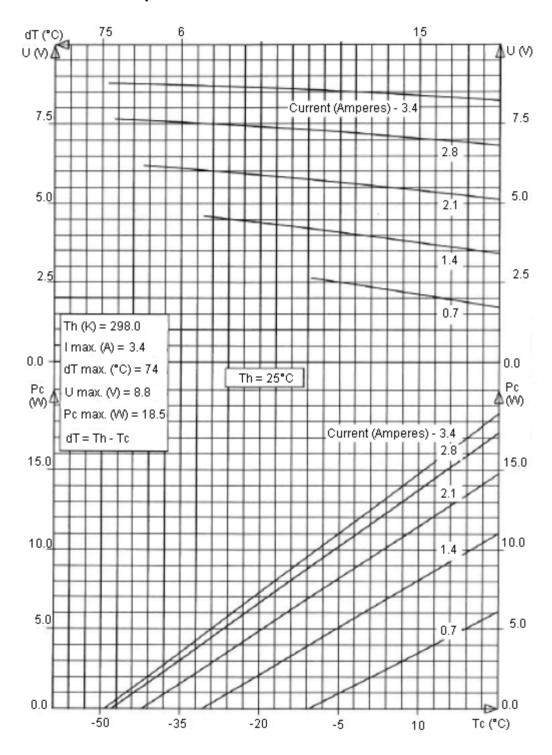
Dimensions : Millimetres



Thermoelectric Module



Performance Graph



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